506761962 07/13/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chun-Sheng Chen	06/24/2021
Yu-Chih Chen	07/09/2021

RECEIVING PARTY DATA

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City:	HSINCHU		
State/Country:	TAIWAN		

PROPERTY NUMBERS Total: 1

Property Type	Number		
Application Number:	17373790		

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NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	07/13/2021

Total Attachments: 4

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PATENT 506761962 REEL: 056830 FRAME: 0934

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

COMPUTER-IMPLEMENTED METHOD OF PERFORMING VOLTAGE RULE CHECK IN AN ELECTRONIC DESIGN AUTOMATION PLATFORM

As the below named inventor, I hereby declare that: This declaration is directed to:				
☑ The attached application, or				
☐ United States application number		filed	filed on ,	
☐ PCT international application	number	file	filed on	
The above-identified application was	made or authorized to	be made by me.		-
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.				
I hereby acknowledge that any willful false statement made in this declaration is punishable under18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.				
In consideration of the payment by	Powerchip Semico		having a postal add	ress of
NO.18, LI-HSIN RD. 1, HSINCE	IU SCIENCE PARK	, HSINCHU 30	0, Taiwan, R.O.C.	
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	o I of the sum of One D nd valuable consideration	ollar (\$ 1.00), the on.	receipt of which is he	reby
I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.				
I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;				
I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal				
representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof. IN WITNESS WHEREOF, I have hereunto set hand and seal this on the date(s) indicated.				
Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.				

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NPO#PSM-P0014-USA:0 CUST#PT.AP-2228

F#NPO-P0002E-US1201 DSB0-110U021815

Docket No PSMP0014USA

LEGAL NAME OF INVENTOR(ASSIGNOR)				
Inventor:	Chun-Sheng Chen	D.	ate:	24/06/2021
Signature:	Chun-Shenp	Chen		

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NPO#PSM-P0014-USA:0 CUST#PT.AP-2228 F#NPO-P0002E-US1201 DSB0-110U021815

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of invention:

COMPUTER-IMPLEMENTED METHOD OF PERFORMING VOLTAGE RULE CHECK IN AN ELECTRONIC DESIGN AUTOMATION PLATFORM

As the below named inventor, I herel This declaration is directed to:	by declare that:			
☑ The attached application, or				
☐ United States application number		_filed on	, (or
□ PCT international application number file			on	
The above-identified application was	made or authorized to be made	by me.		
I believe that I am the original inventor application.	or or an original joint inventor of a	a claimed	invention in the	
I hereby acknowledge that any willful under18 U.S.C. 1001 by fine or impri	false statement made in this dec sonment of not more than five (5)	claration is) years, o	s punishable r both.	
In consideration of the payment by	Powerchip Semiconductor Manufacturing Corporation		naving a postal addre	ss of
NO.18, LI-HSIN RD. 1, HSINCH	U SCIENCE PARK, HSINCI	HU 300,	Taiwan, R.O.C.	
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	I of the sum of One Dollar (\$ 1.0 d valuable consideration.	00), the re	ceipt of which is here	by
I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.				
I hereby covenant that no assignmen entered into which would conflict with	t, sale, agreement or encumbran this assignment;	ice has be	een or will be made o	r
I further covenant that ASSIGNEE wi and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion and said Letters Patent and l stify as to the same in any interfe	legal equi rence, liti	valents as may be	
representatives any and all papers, in maintain, issue and enforce said app equivalents thereof which may be ne IN WITNESS WHEREOF, I have her	lication, said invention and said L cessary or desirable to carry out	etters Pa	tent and said ses thereof.	
Note: An application data sheet (PTC inventive entity, must accompany this	D/SB/14 or equivalent), including is form. Use this form for <u>each add</u>	naming th ditional in	ue entire ventor.	

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NPO#PSM-P0014-USA:0 CUST#PT.AP-2228 F#NPO-P0002E-US1201 DSB0-110U021815

Docket No PSMP0014USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Yu-

Yu-Chih Chen

Date:

JUL 09 2021

Signature:

Yu chih chen

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F#NPO-P0002E-US1201 DSB0-110U021815

NPO#PSM-P0014-USA:0 CUST#PT.AP-2228

RECORDED: 07/13/2021

PATENT REEL: 056830 FRAME: 0938